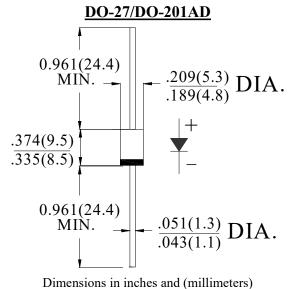
# SB3150 3.0AMPS. SCHOTTKY BARRIER RECTIFIERS

#### **FEATURE**

- . High current capability
- . Low forward voltage drop
- . Low power loss, high efficiency
- . High surge capability
- . High temperature soldering guaranteed 260°C /10sec/ 0.375" lead length at 5 lbs tension

#### **MECHANICAL DATA**

- . Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
- . Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
- . Polarity: color band denotes cathode
- . Mounting position: any



Billions in mones and (minimisers)

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at  $25\,^{\circ}$ C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

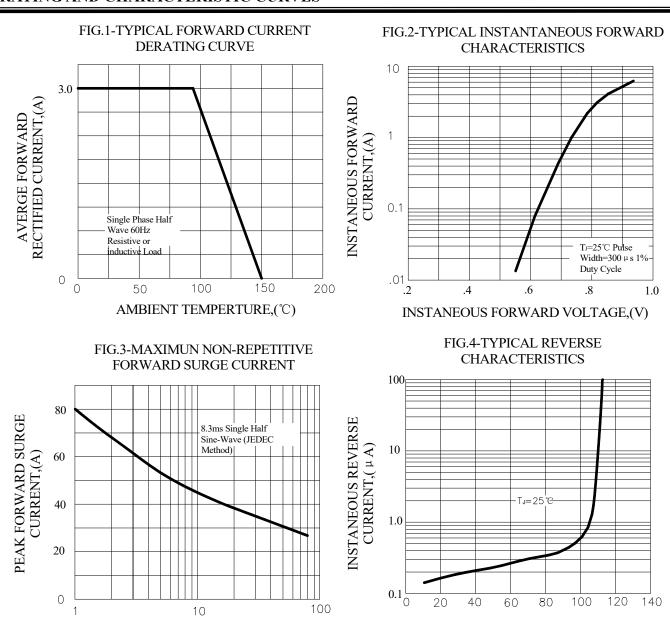
Type Number	SYM BOL	SB3150	units
Maximum Recurrent Peak Reverse Voltage	$V_{ m RRM}$	150	V
Maximum RMS Voltage	$V_{ m RMS}$	105	V
Maximum DC blocking Voltage	$V_{ m DC}$	150	V
Maximum Average Forward Rectified Current .375"(9.5mm) lead length	I <sub>F(AV)</sub>	3.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	$I_{ m FSM}$	80.0	A
Maximum Forward Voltage at 3.0A DC	$V_{\mathrm{F}}$	0.95	V
Maximum DC Reverse Current @T <sub>J</sub> =25°C at rated DC blocking voltage @T <sub>J</sub> =100°C	$I_{ m R}$	0.1 10.0	mA
Typical Junction Capacitance (Note 1)	$C_{ m J}$	80	pF
Typical Thermal Resistance (Note 2)	R <sub>(JA)</sub>	45	°C /W
Storage Temperature	TSTG	-55 to +150	°C
Operation JunctionTemperature	$T_{ m J}$	-55 to +150	°C

#### Note:

- 1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
- 2. Thermal Resistance from Junction to Ambient at 0.375" (9.5mm) lead length, vertical P.C.Board Mounted.

#### RATING AND CHARACTERISTIC CURVES

NUMBER OF CYCLES AT 60Hz

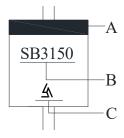


PERCENT OF RATED PEAK REVERSE

VOLTAGE,(%)

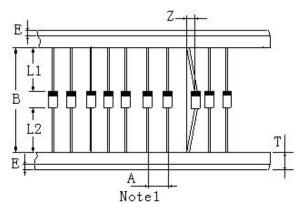
## Marking and packaging illustration

## 1. Marking



SYMBOL	Explanation
A	Color Band Denotes Cathode
В	Product Name
C	Trademark

## 2. Packaging



ITEM	SYMBOL	SPECIFICATIONS	SPECIFICATIONS
		(mm)	(inch)
Component alignment	Z	1.2max	0.048max
Tape width	T	$6.0 \pm 0.4$	$0.236 \pm 0.016$
Exposed adhesive	Е	0.8max	0.032max
Body eccentricity	L1-L2	1.0max	0.040max
Component	A	$10.0 \pm 0.5$	$0.4 \pm 0.02$
Inner tap	В	52.0~53.5	2.05~2.11

NOTE:

Each component lead shall be sandwiched between tapes for a minimum of 2.5mm (0.1inch)